

# Crystal Clear Technology

## Product Specification

### **G64128X15 series**

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1.0 Table of Contents

	Page
1. Table of Contents	1
2. Record of revision	2
3. General specification	3
4. Absolute maximum ratings	4
5. Electrical characteristics	4
6. Environmental requirement	4
7. LCD specification	5 ~ 7
8. Interface	8
9. Functional Description	9 ~ 16
10. Instructions	17 ~ 18
11. Power supply	19
12. Quality assurance	20 ~ 25
13. Precautions in use LCM	26 ~ 27
14. Outline drawing	28
15. LCD Segment and Common Layout	29



2.0 Record of revision

Rev	Date	Item	Page	Comment	Originator	Checked By
1.0	27/11/08			Initial Release	Syam	Azhar
2.0	04/12/08			Deletion of Serial interface and Parallel 6800 interface details	Syam	Azhar
3.0	15/12/08	3	3	Deletion of Serial interface extension. G64128x15xxx00 now refers to Parallel 8080 interface only.	Syam	Azhar



3.0 General specification

Display format: Graphics 128 (w) x 64 (h) dots

Dot size: 0.48 (w) x 0.48 (h) mm

Dot pitch: 0.52 (w) x 0.52 (h) mm

View area: 70.7 (w) x 38.8 (h) mm

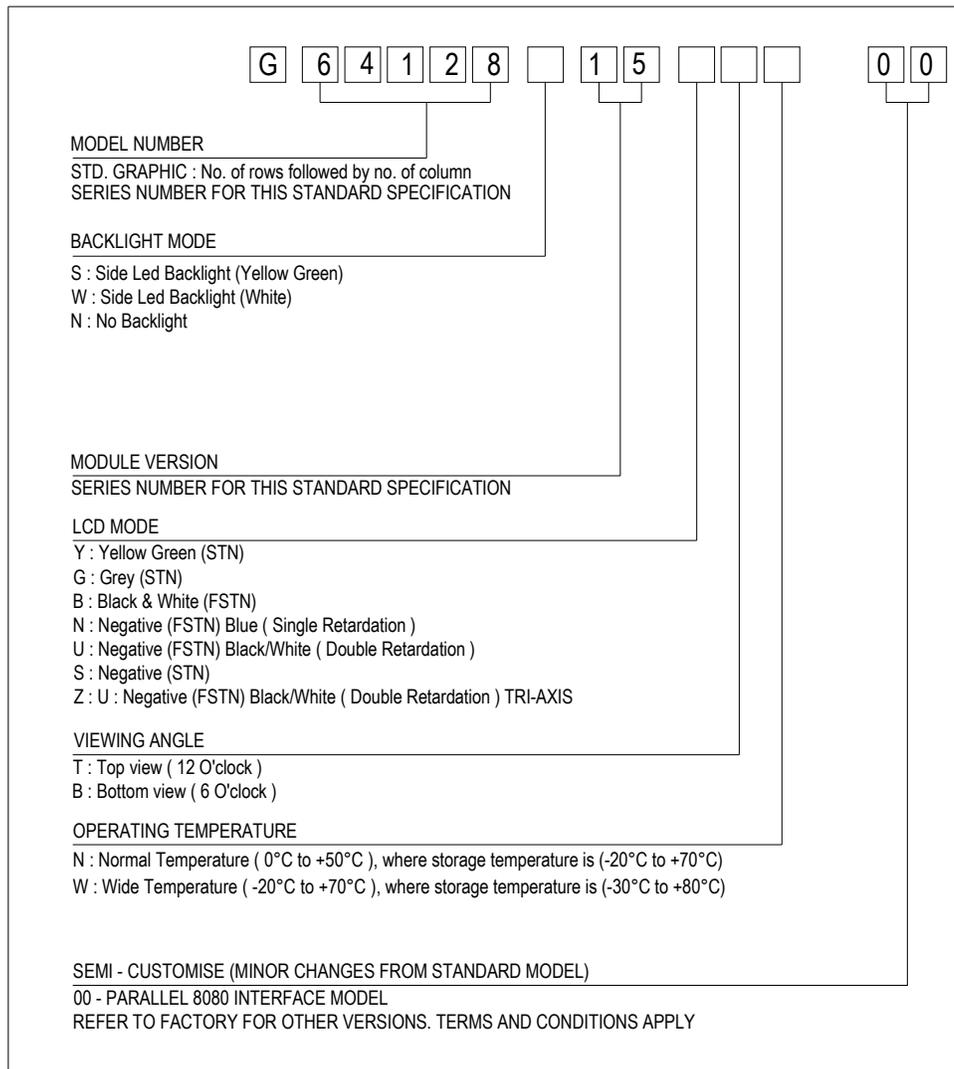
Active area: 66.52 (w) x 33.24 (h) mm

General dimensions: 93.7 (w) x 52.4 (h) x 5.5 (t) mm

Controller/Driver: SPLC501C-C1 or equivalent

Interface: Parallel 8080

Driving method: 1/64 duty, 1/9 bias



**4.0 Absolute maximum rating (at V<sub>SS</sub> = 0V, ambient temperature = 25°C)**

NO	ITEM	SIMBOL	MIN	MAX	UNIT
1.	Operating Voltage Range	V <sub>DD</sub>	-0.3	7.0	V
2.	Operating Temperature	T <sub>op</sub>	Refer page 3		°C
3.	Storage Temperature	T <sub>st</sub>	Refer page 3		°C

**5.0 Electrical characteristics**

NO	ITEM	SYMBOL	CONDITION	MIN	TYP	MAX	UNIT
1.	Operating Voltage	V <sub>DD</sub>	-	2.7	3.0	3.3	V
2.	Power Supply voltage	V <sub>LCD</sub>	25°C	10.0±5%			V
3.	Current Supply	I <sub>DD</sub>	V <sub>DD</sub> = 3.0V 4x Boosting	-	120	400	uA

**5.1 Backlight Options**

NO	COLOR	FORWARD VOLTAGE (V)			FORWARD CURRENT (mA)			MIN BRIGHTNESS (cd/m <sup>2</sup> ) *
		Min	Typ.	Max	Min	Typ.	Max	
1.	Yellow Green	-	4.2	-	-	80	120	30
2.	White	-	3.1	-	-	40	70	100

- \*Note : 1. Brightness measured at backlight surface.  
 2. On LCD surface, brightness is only about 10% to 15% of backlight brightness.  
 3. Lifetime of backlight: For YG = 50K hrs. For White, Blue = 20K hrs

**6.0 Environmental requirements**

NO	ITEM	CONDITION
1.	Operating Temperature	Refer page 3
2.	Storage Temperature	Refer page 3
3.	Operating Humidity	5% to 95%RH
4.	Cycle Test	0 C @ 30 min to 50 C @ 30min for 1 cycle run for 10 cycles
5.	Lifetime	50000 HOURS (excluding backlight)

Note: The background on LCD has the possibility to be changed in different temperature range.



7.0 LCD specification

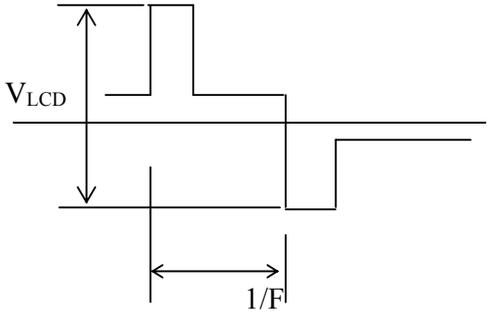
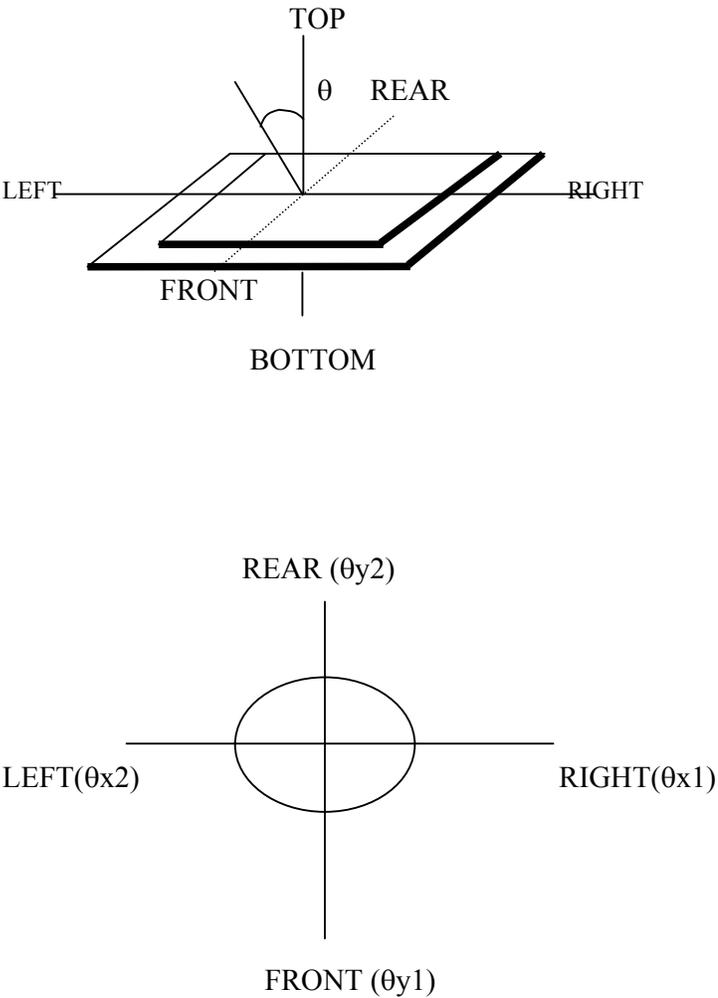
7.1 Electro-optical characteristics (at ambient temperature = 25°C)

NO	ITEM	SYMBOL	CONDITION	LCD TYPE							REF.
				STN YG	STN GREY	STN -VE BLUE/PURPLE	FSTN +VE B/W	FSTN -VE BLUE	FSTN -VE TRUE B/W	FSTN -VE TRI AXIS	
1	Operating Voltage (Volt)	V <sub>LCD</sub>	$\theta = 0$ Cr = max	10.0 ± 5%							7.1.1
2	Viewing Angle (Deg)	$\theta x 1$	CR ≥ 2 V <sub>LCD</sub> = 14.7V	+25	+20	+35	+25	+35	+35	+40	7.1.2
		$\theta x 2$		-25	-20	-35	-25	-35	-40	-40	
		$\theta y 1$		-30	-25	-35	-30	-35	-35	-50	
		$\theta y 2$		+30	+25	+35	+30	+35	+35	+30	
3	Contrast Ratio	CR	$\theta = 0^0$ V <sub>LCD</sub> = 14.7V	3.0	2.3	6.0	3.0	6.0	20	20	7.1.3
4	Response Time (msec)	Rise Time (Tr)	$\theta = 0^0$	200							7.1.4
		Decay Time (Td)	$\theta = 0^0$	250							

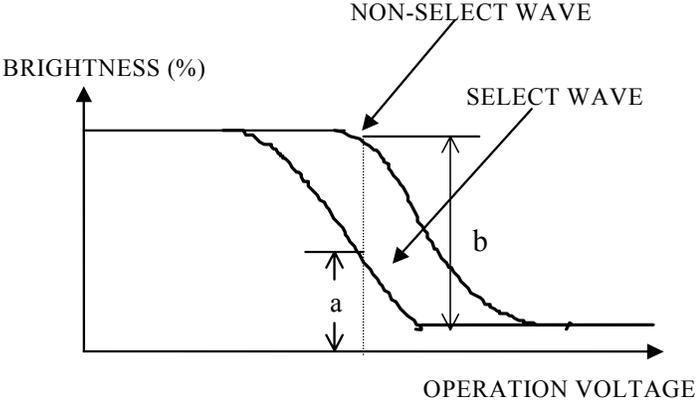
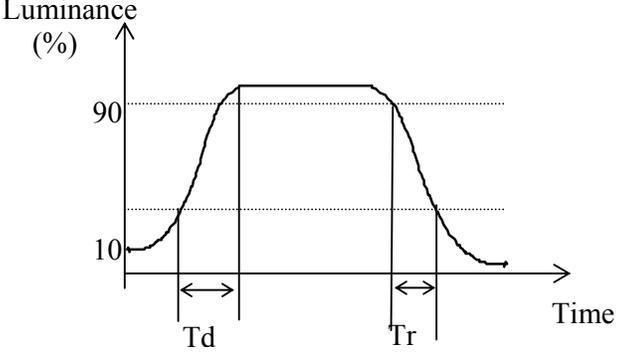
Note:

1. Viewing angle data is based on bottom view product by default. Should it be a top view product, values are then swap.
2. Contrast ratio is based on typical data when using white colour as backlight.
3. Equipment Used Eldim; Ez Contrast 120R , Spot Size = 2mm



NO	CHARACTERISTICS	DEFINITIONS
7.1.1	<b>Definition of Operating Voltage (<math>V_{LCD}</math>)</b>	 <p><math>V_{LCD}</math> : Operating Voltage F : Frame Frequency</p>
7.1.2	<b>Definition of Viewing Angle</b>	



<p>7.1.3</p>	<p><b>Definition of Contrast Ratio</b></p>	 <p>Contrast Ratio = <math>\frac{\text{Brightness of non-selected state (b)}}{\text{Brightness of selected state (a)}}</math></p> <p><b>Conditions</b></p> <ul style="list-style-type: none"><li>(a) Operating Voltage: <math>V_{LCD}</math></li><li>(b) Temperature: <math>25^{\circ}C</math></li><li>(c) Viewing Angle, <math>\theta = 0^{\circ}</math></li></ul>
<p>7.1.4</p>	<p><b>Response Time</b></p>	 <p><math>T_r</math>: Measured between 10% and 90% of LCD segment maximum response with <math>V_{ON}</math>.</p> <p><math>T_d</math>: With voltage switches to zero and the instant LCD segment reaches 10% of its maximum response.</p>

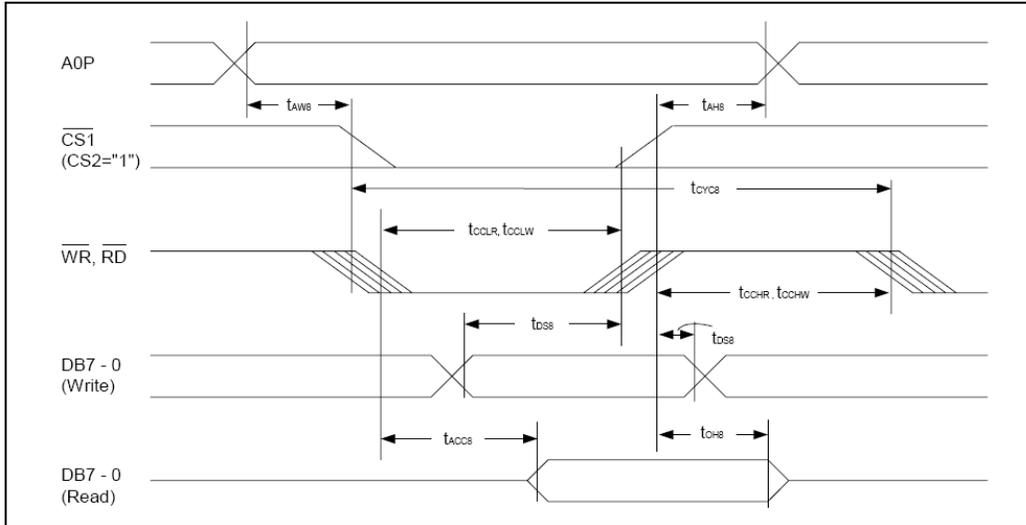
**8.0 Interface**

<b>Display Driver</b>	<b>SPLC501C-C1 OR EQUIVALENT</b>	
<b>Pin No</b>	<b>Symbol</b>	<b>Description</b>
1	/CS1	Chip select signal
2	/RESET	Reset
3	A0P	Data / instruction signal
4	/WR	Write signal (8080)
5	/RD	Read signal (8080)
6	D0	Parallel data input
7	D1	Parallel data input
8	D2	Parallel data input
9	D3	Parallel data input
10	D4	Parallel data input
11	D5	Parallel data input
12	D6	Parallel data input
13	D7	Parallel data input
14	VDD	Power supply
15	VSS	Power supply
16	VOUT	DC/DC voltage converter
17	C3N	DC/DC voltage converter
18	C1P	DC/DC voltage converter
19	C1N	DC/DC voltage converter
20	C2N	DC/DC voltage converter
21	C2P	DC/DC voltage converter
22	V1	LCD biasing voltages
23	V2	LCD biasing voltages
24	V3	LCD biasing voltages
25	V4	LCD biasing voltages
26	V5	LCD biasing voltages



9.0 Functional Descriptions  
 9.1 Read/Write timing characteristics

Read/Write characteristics (8080 series MPU)



(VDD = 4.5V to 5.5V, T<sub>A</sub> = 25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0P	$t_{AHS}$		0	-	ns
Address setup time	A0P	$t_{AWS}$		0	-	ns
System cycle time	A0P	$t_{CYC8}$		166	-	ns
Control L pulse width ( WR )	WR	$t_{CCLW}$		30	-	ns
Control L pulse width ( RD )	RD	$t_{CCLR}$		70	-	ns
Control H pulse width ( WR )	WR	$t_{CCHW}$		30	-	ns
Control H pulse width ( RD )	RD	$t_{CCHR}$		30	-	ns
Data setup time	DB7 - 0	$t_{DSS}$		30	-	ns
Address hold time		$t_{OH8}$		10	-	ns
RD access time		$t_{ACC8}$	C <sub>L</sub> = 100pF	-	70	ns
Output disable time	$t_{OH8}$	5.0		50	ns	



Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0P	$t_{AHS}$		0	-	ns
Address setup time		$t_{AWS}$		0	-	ns
System cycle time	A0P	$t_{CYCS}$		300	-	ns
Control L pulse width (WR)	WR	$t_{CCLW}$		60	-	ns
Control L pulse width (RD)	RD	$t_{CCLR}$		120	-	ns
Control H pulse width (WR)	WR	$t_{CCHW}$		60	-	ns
Control H pulse width (RD)	RD	$t_{CCHR}$		60	-	ns
Data setup time	DB7 - 0	$t_{DS8}$	$C_L = 100pF$	40	-	ns
Address hold time		$t_{DHS}$		15	-	ns
RD access time		$t_{ACC8}$		-	140	ns
Output disable time		$t_{OHS}$		10	100	ns

(VDD = 2.4V to 2.7V, T<sub>A</sub> = 25°C)

Item	Signal	Symbol	Condition	Rating		Units
				Min.	Max.	
Address hold time	A0P	$t_{AHS}$		0	-	ns
Address setup time		$t_{AWS}$		0	-	ns
System cycle time	A0P	$t_{CYCS}$		1000	-	ns
Control L pulse width (WR)	WR	$t_{CCLW}$		120	-	ns
Control L pulse width (RD)	RD	$t_{CCLR}$		240	-	ns
Control H pulse width (WR)	WR	$t_{CCHW}$		120	-	ns
Control H pulse width (RD)	RD	$t_{CCHR}$		120	-	ns
Data setup time	DB7 - 0	$t_{DS8}$	$C_L = 100pF$	80	-	ns
Address hold time		$t_{DHS}$		30	-	ns
RD access time		$t_{ACC8}$		-	280	ns
Output disable time		$t_{OHS}$		10	200	ns

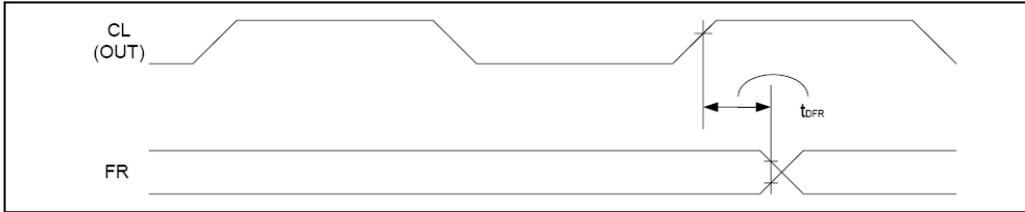
**Note1:** The input signal rise time and fall time ( $t_r, t_f$ ) is specified at 15 ns or less. When the system cycle time is extremely fast,  $(t_r + t_f) \leq (t_{CYCS} - t_{CCLW} - t_{CCHW})$  for  $(t_r + t_f) \leq (t_{CYCS} - t_{CCLR} - t_{CCHR})$  are specified.

**Note2:** All timing is specified using 20% and 80% of VDD as the reference.

**Note3:**  $t_{CCLW}$  and  $t_{CCLR}$  are specified as the overlap between CS1 being 'L' (CS2 = 'H') and WR and RD being at the 'L' level.



9.2 Display control output timing



(VDD = 4.5V to 5.5V, T<sub>A</sub> = 25°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
FR delay time	FR	$t_{DFR}$	$C_L = 50pF$	-	10	40	ns

(VDD = 2.7V to 4.5V, T<sub>A</sub> = 25°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
FR delay time	FR	$t_{DFR}$	$C_L = 50pF$	-	20	80	ns

(VDD = 2.4V to 2.7V, T<sub>A</sub> = 25°C)

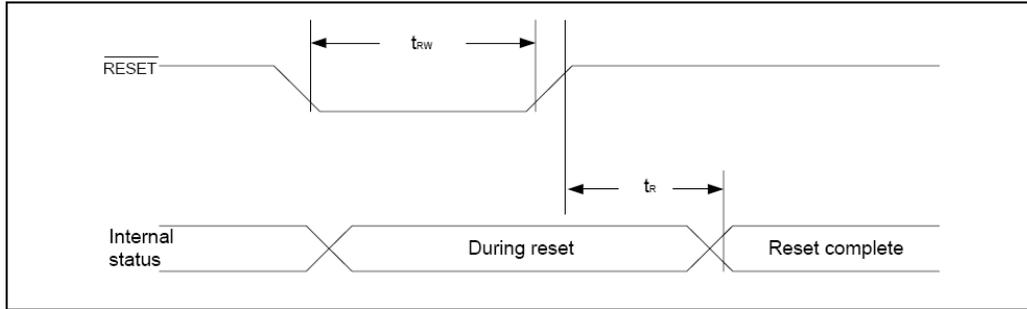
Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
FR delay time	FR	$t_{DFR}$	$C_L = 50pF$	-	50	200	ns

Note1: Valid only when the master mode is selected.

Note2: All timing is based on 20% and 80% of VDD.



### 9.3 Reset timing



(VDD = 4.5V to 5.5V, TA = 25°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
Reset time		$t_R$	-	-	0.5	$\mu\text{s}$	
Reset 'L' pulse width	RES	$t_{RW}$	-	0.5	-	$\mu\text{s}$	

(VDD = 2.7V to 4.5V, TA = 25°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
Reset time		$t_R$	-	-	1.0	$\mu\text{s}$	
Reset 'L' pulse width	RES	$t_{RW}$	-	1.0	-	$\mu\text{s}$	

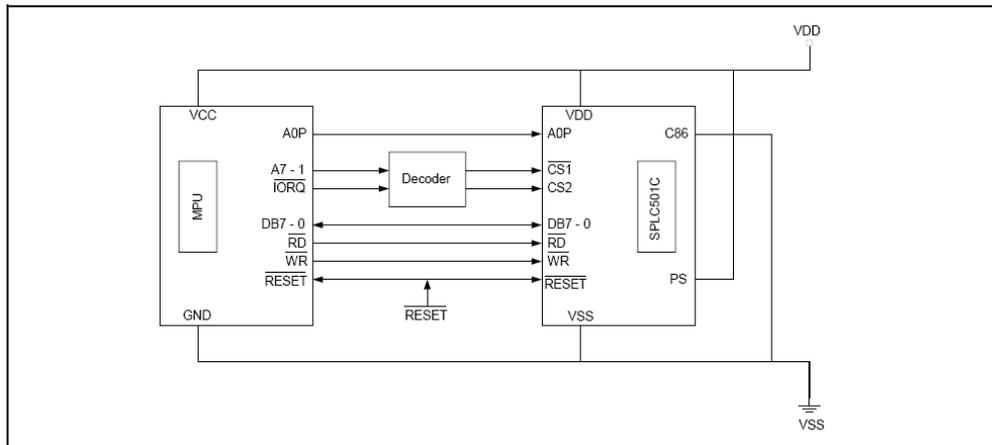
(VDD = 2.4V to 2.7V, TA = 25°C)

Item	Signal	Symbol	Condition	Rating			Units
				Min.	Typ.	Max.	
Reset time		$t_R$	-	-	1.5	$\mu\text{s}$	
Reset 'L' pulse width	RES	t	-	1.5	-	$\mu\text{s}$	

Note: All timing is specified with 20% and 80% of VDD as the standard.

## 9.2 Application Circuits

### 9.2.1 8080 MPU Interface





10. Instruction Set

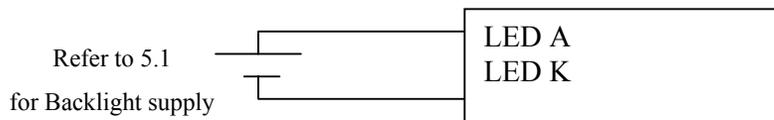
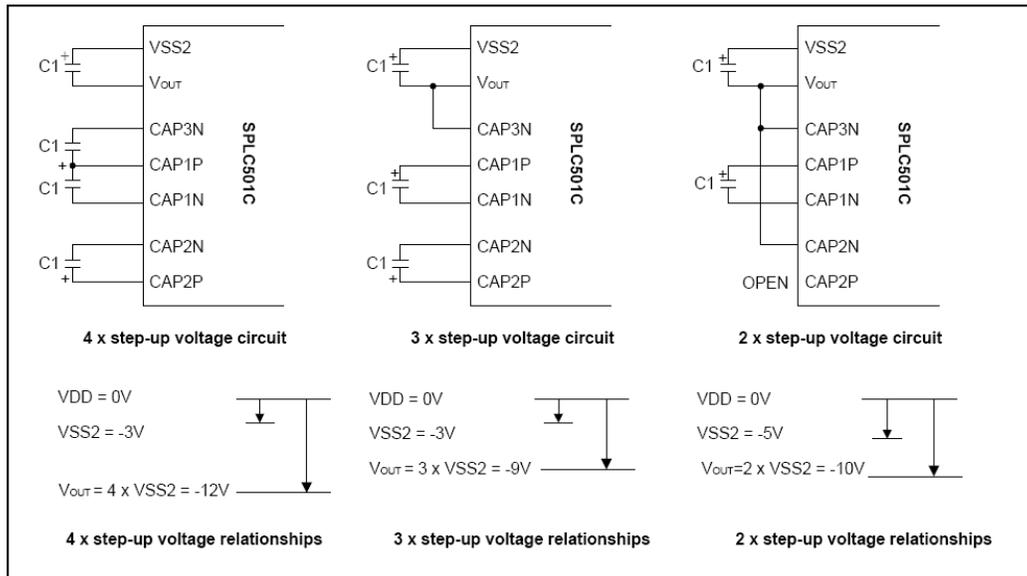
Command	Command Code											Function	
	A0P	RD	WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
1). Display ON/OFF	0	1	0	1	0	1	0	1	1	1	0	LCD display ON/OFF 0: OFF, 1: ON	
2). Display start line set	0	1	0	0	1	Display start address					1	Sets the display RAM display start line address	
3). Page address set	0	1	0	1	0	1	1	Page address				1	Sets the display RAM page address
4). Column address set upper bit	0	1	0	0	0	0	1	Most significant column address				1	Sets the most significant 4 bits of the display RAM column address.
Column address set lower bit	0	1	0	0	0	0	0	Least significant column address				1	Set the least significant 4 bits of the display RAM column address.
5). Status read	0	0	1	Status				0	0	0	0	1	Reads the status data
6). Display data write	1	1	0	Write data								0	Writes to the display RAM
7). Display data read	1	0	1	Read data								0	Reads from the display RAM
8). ADC select	0	1	0	1	0	1	0	0	0	0	0	Sets the display RAM address SEG output correspondence 0: normal, 1:reverse	
9). Display normal/reverse	0	1	0	1	0	1	0	0	1	1	0	Sets the LCD display normal/ reverse 0: normal, 1:reverse	
10). Display all points ON/OFF	0	1	0	1	0	1	0	0	1	0	0	Display all points 0: normal display 1: all points ON	
11). LCD bias set	0	1	0	1	0	1	0	0	0	1	0	Sets the LCD driver voltage bias ratio SPLC501C.....0:1/9, 1:1/7	
12). Read/modify/write	0	1	0	1	1	1	0	0	0	0	0	Column address increment At write: +1 At read: 0	
13). End	0	1	0	1	1	1	0	1	1	1	0	Clear read/modify/write	
14). Reset	0	1	0	1	1	1	0	0	0	1	0	Internal reset	
15). Common output mode select	0	1	0	1	1	0	0	0	*	*	*	Select COM output scan direction 0: normal direction, 1: reverse direction	
16). Power control set	0	1	0	0	0	1	0	1	Operating mode			Select internal power supply operating mode	
17). V <sub>s</sub> voltage regulator internal resistor ratio set	0	1	0	0	0	1	0	0	Resistor ratio			Select internal resistor ratio (Rb/Ra) mode	
18). Electronic volume mode set	0	1	0	1	0	0	0	0	0	0	1	Set the V <sub>s</sub> output voltage electronic volume register	
Electronic volume register set	0	1	0	*	*	Electronic volume value							



Command	Command Code										Function			
	A0P	RD	WR	DB7	DB6	DB5	DB4	DB3	DB2	DB1		DB0		
19). Static indicator ON/OFF Static indicator Register set				1	0	1	0	1	1	0	0	0	1	0: OFF, 1: ON Set the flashing mode
20). Page Blink Page selection	0	1	0	1	1	0	1	0	1	0	1		P7 - 0: 1 - blinking page 0 - no blinking, normal display	
21). Driving Mode Set Mode selection	0	1	0	1	1	0	1	0	0	1	0		Set the driving mode register Driving capability (D1, D0): (1,1)>(0,0)>(0,1)>(1,0)	
22). Power saver													Display OFF and display all points ON compound command	
23). NOP	0	1	0	1	1	1	0	0	0	1	1		Command for non-operation	
24). Test	0	1	0	1	1	1	1	*	*	*	*		Command for IC test. Do not use this command	



### 11. Power Supply

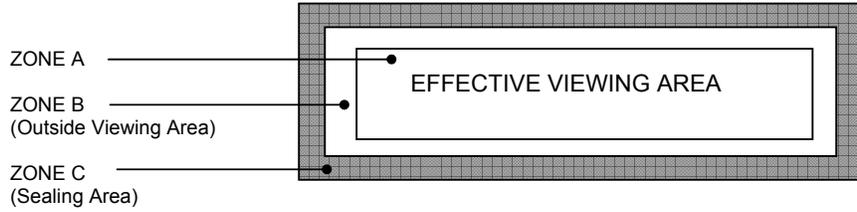


For backlight version only



12.0 Quality Assurance

**12.1 ZONE DEFINITION**



**12.2 REJECTION CRITERIA**

12.2.1 DIMENSIONAL DEFECTS

Defect Category	Defect Description	Criterion	Drawing Specification
Glass Size	Dimensions of LCD, do not conform to the drawing	Reject	Refer to LCD Physical Dimension Drawing
Perimeter Seal Extension	Perimeter seal epoxy enters the effective viewing area	Reject	
End Seal Size	Size of end seal does not meet drawing specification	Reject	Refer to LCD Physical Dimension Drawing

12.2.2 VISUAL DEFECTS

Defect Category	Defect Description	Criterion	Drawing Specification
Fracture	A type of glass breakage containing running cracks. Inspectors should attempt to remove it with fingernail. If removed, evaluate as chip	Reject – if the size is $\geq 30\%$ of the contact ledge width.	<p>The diagram shows a cross-section of a glass ledge. A fracture is shown as a crack in the glass. A dimension line indicates the width of the fracture is <math>\leq 30\%</math> of the ledge width. A note states: 'Fracture does not penetrate through the whole glass thickness'.</p>



Defect Category	Defect Description	Criterion	Drawing Specification
Chip	Chip in cross over area	<p>1) Reject - if the chip causes crossover dot to be exposed</p> <p>2) Chip on outside edge of the glass plate but is greater than 50% of glass thickness at crossover dot is reject able.</p>	
Chip	Chip in contact pad area	Accept if:- a) $X \leq 2.0\text{mm}$ b) $Y \leq 0.5\text{mm}$ c) Z disregard	
	Chip in non-contact pad area	Accept if:- a) $X \leq 6.0\text{mm}$ b) $Y \leq 1.0\text{mm}$ c) Z disregard	
	Chip in perimeter seal area	Accept if:- a) $Y \leq 1/3$ of perimeter seal width (W) b) $X \leq 3.0\text{mm}$ c) Z disregard d) X and Y not touch crossover dot	
Corner Chip	Corner chip within seal area	Accept if:- a) $X \leq 1/3$ of perimeter seal width (W) b) $Y \leq 1/3$ of perimeter seal width (W) c) Z disregard	



Defect Category	Defect Description	Criterion	Drawing Specification
	Corner chip not effecting contact pad / ITO	Accept if:- a) $XY \leq 4\text{mm}^2$ AND b) $Y \leq D$ and $X \leq 2.0\text{mm}$ c) Z disregard	
	Corner chip effecting contact pad / ITO	A) Accept if:- a) $XY \leq 4\text{mm}^2$ AND b) $Y \leq D$ and $X \leq 2.0\text{mm}$  B) Accept if:- a) $X1 \leq 2.0\text{mm}$ b) $Y1 \leq 0.5\text{mm}$  Z disregard	
Glass flare	A thin layer of glass flare at contact area	Accept if:- a) Flare thickness $\leq \frac{1}{4} W$ when $W \leq 3\text{mm}$  b) Flare thickness $\leq 1\text{mm}$ when $W > 3\text{mm}$  W: Contact ledge width	
Glass burr	A rough edge(s) left along the scribing edge (i.e. along the edges of display)	Reject – if the burr cause undersize or oversize of the LCD	Refer to LCD Physical Dimension Drawing
Rainbow	Colored ring in sharp blotches observed	Reject – if 3 or more colored rings in sharp blotches of color are observed. (Limit samples should be used when applicable)	



Defect Category	Defect Description	Criterion	Drawing Specification
Discoloration		Reject - if the discolorations enter the active viewing area of LCD. Color of the LCD shall follow product specification as specified in the manufacturing specification	
Air Void	LC does not fulfill the display	Reject	
Fill end contamination	Discoloration at end seal area	Reject if discoloration exceeded the baffle (for display with baffle) or viewing area (for display without baffle)	

12.2.3 POLARIZER DEFECT

Defect Category	Defect Description	Criterion	Drawing Specification
Polarizer defect	Polarizer coverage	<ol style="list-style-type: none"> <li>1- Polarizer should cover effective viewing area of display.</li> <li>2- It is acceptable if perimeter seal border at all sides could be seen.</li> <li>3- It is acceptable if polarizer attaching position meeting the tolerance mentioned in the drawing.</li> <li>4- It is reject able if polarizer edge jagged and not even</li> </ol>	Refer to LCD Physical Dimension Drawing
	Polarizer Peeling / delamination	1- Reject if any edge or corner of the polarizer is lifted up or not adheres to the glass	
	Polarizer Scratches	<ol style="list-style-type: none"> <li>1- Any scratch should be acceptable if it is not visible from viewing distance at head of position</li> <li>2-Polarizer scratch in viewing area is reject able if it is visible from the specified viewing distance</li> <li>3-Defect, which is visible under surface glare, should be disregard</li> </ol>	
	Polarizer damage	<ol style="list-style-type: none"> <li>1-Stain mark or depression in front polarizer surface should be acceptable if it is not visible from viewing distance at head on position.</li> <li>2-Defect, which is visible under surface glare, should be disregard</li> </ol>	



Defect Category	Defect Description	Criterion			Drawing Specification
	Polarizer bubble / Foreign material	Zone /			Acceptable No.
		Dimension	A		
		$D \leq 0.15\text{mm}$	NC	B	C
		$0.15 < D \leq 0.30\text{mm}$	3	NC	NC
		$0.30 < D \leq 0.50\text{mm}$	2	5	NC
		$0.50 < D \leq 1.0\text{mm}$	0	3	NC
		NC: No count		1	NC
		D: Mean Diameter of Defect			
		Accept - if air bubble at the seal area does not propagate into effective viewing area			

$D = (A + B)/2$

12.2.4 FUNCTIONAL DEFECT

Defect Category	Defect Description	Criterion			Drawing Specification	
Missing common	Part of the pattern does not light up	Reject				
Missing segment	One or few segment does not light up	Reject				
Common-common short	Common and common connected	Reject				
Segment-segment short	Segment and segment connected	Reject				
Common – segment short	Common and segment connected	Reject				
Wrong viewing angle	Wrong viewing angle	Reject if display viewing angle not conform to customer requirement				
Metal residue	Extra spot lights up at the border of the segment.	Accept if $\leq 0.20\text{mm}$ (mean diameter)				
Slow response	Response of the display on one side slower than the other side	Reject if it is visible at 30cm distance				
Reverse twist/tilt	Segment are darker or clearer than other area of the same segment	Reject				
Misalignment	Segment fatter or smaller or extra segment	Reject if $> 10\%$ of designed segment width and visible at 30cm distance				
Pin Hole	Pin hole / void at light up segment	Zone /			<p><math>D = (A + B)/2</math></p>	
		Dimension	Acceptable No.			
		$D \leq 0.10\text{mm}$	NC	NC		NC
		$0.10 < D \leq 0.20\text{mm}$	3	3		NC
		NC: No count				
		D: Mean Diameter of Defect				



Defect Category	Defect Description	Criterion	Drawing Specification
Segment Smearing	Light up segment smear	Reject	
Dim segment	Display shows poor contrast at pre set voltage	Reject	

12.2.5 BLACK SPOT, WHITE SPOT AND FOEREIGN MATERIAL

Defect Category	Defect Description	Criterion	Drawing Specification																							
Black Spot, White Spot and Foreign Material	Black Spot, White Spot and Foreign Material	<table border="1"> <thead> <tr> <th rowspan="2">Zone / Dimension</th> <th colspan="3">Acceptable No.</th> </tr> <tr> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td><math>D \leq 0.10\text{mm}</math></td> <td>NC</td> <td>NC</td> <td>NC</td> </tr> <tr> <td><math>0.10 &lt; D \leq 0.20\text{mm}</math></td> <td>3</td> <td>3</td> <td>NC</td> </tr> <tr> <td><math>0.20 &lt; D \leq 0.30\text{mm}</math></td> <td>1</td> <td>2</td> <td>NC</td> </tr> <tr> <td><math>D &gt; 0.30 \text{ mm}</math></td> <td>0</td> <td>0</td> <td>NC</td> </tr> </tbody> </table>	Zone / Dimension	Acceptable No.			A	B	C	$D \leq 0.10\text{mm}$	NC	NC	NC	$0.10 < D \leq 0.20\text{mm}$	3	3	NC	$0.20 < D \leq 0.30\text{mm}$	1	2	NC	$D > 0.30 \text{ mm}$	0	0	NC	<p><math>D = (A + B)/2</math></p>
		Zone / Dimension		Acceptable No.																						
			A	B	C																					
		$D \leq 0.10\text{mm}$	NC	NC	NC																					
		$0.10 < D \leq 0.20\text{mm}$	3	3	NC																					
		$0.20 < D \leq 0.30\text{mm}$	1	2	NC																					
		$D > 0.30 \text{ mm}$	0	0	NC																					
NC: No count																										
D: Mean Diameter of Defect																										

12.2.6 LINE SHAPE AND SCRATCHES

Defect Category	Defect Description	Criterion	Drawing Specification																									
Line shape and scratches	Line shape and scratches	<table border="1"> <thead> <tr> <th colspan="2">Zone /Dimension</th> <th colspan="3">Acceptable No.</th> </tr> <tr> <th>X</th> <th>Y</th> <th>A</th> <th>B</th> <th>C</th> </tr> </thead> <tbody> <tr> <td>-</td> <td><math>&lt; 0.01\text{mm}</math></td> <td>NC</td> <td>NC</td> <td>NC</td> </tr> <tr> <td><math>&lt; 2 \text{ mm}</math></td> <td><math>&lt; 0.02\text{mm}</math></td> <td>1</td> <td>1</td> <td>NC</td> </tr> <tr> <td><math>&lt; 1 \text{ mm}</math></td> <td><math>&lt; 0.0 2\text{mm}</math></td> <td>1</td> <td>2</td> <td>NC</td> </tr> </tbody> </table>	Zone /Dimension		Acceptable No.			X	Y	A	B	C	-	$< 0.01\text{mm}$	NC	NC	NC	$< 2 \text{ mm}$	$< 0.02\text{mm}$	1	1	NC	$< 1 \text{ mm}$	$< 0.0 2\text{mm}$	1	2	NC	
		Zone /Dimension		Acceptable No.																								
		X	Y	A	B	C																						
		-	$< 0.01\text{mm}$	NC	NC	NC																						
		$< 2 \text{ mm}$	$< 0.02\text{mm}$	1	1	NC																						
		$< 1 \text{ mm}$	$< 0.0 2\text{mm}$	1	2	NC																						

Note: Total defects shall not exceed five



### 13. Precaution for using LCM

#### 1. Liquid Crystal Display (LCD)

LCD is made up of glass, organic sealant, organic fluid and polymer based polarizers. The following precautions should be taken when handling.

- b) Keep the temperature within the range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- c) Do not contact the exposed polarizer with anything harder than HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.
- d) Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or colour fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- e) Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- f) Do not drive LCD with DC voltage.

#### 2. Liquid Crystal Display Modules.

##### 2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modification. The following should be noted.

- a) Do not tamper in any way with the tabs on the metal frame.
- b) Do not modify the PCB by drilling extra holes, changing its outline, moving its component or modifying its pattern.
- c) Do not touch the elastomer connector, especially insert a backlight panel (for example, EL)
- d) When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

- a) Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

##### 2.2 Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- a) The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- b) The modules should be kept in antistatic bags or other containers to static for storage.
- c) Only properly grounded soldering irons should be used.
- d) If an electric screwdriver is used, it should be well grounded and shielded from commutator spark.
- e) The normal static prevention measures should be observed for work clothes and working benches, the latter conductive (rubber) mat is recommended.
- f) Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

##### 2.3 Soldering

- a) Solder only to the I/O terminals.
- b) Use only soldering irons with proper grounding and no leakage.
- c) Soldering temperature: 280 °C
- d) Soldering time: 3 to 4 sec
- e) Use eutectic solder with resin flux fill.
- f) If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed afterwards.



#### 2.4 Operation

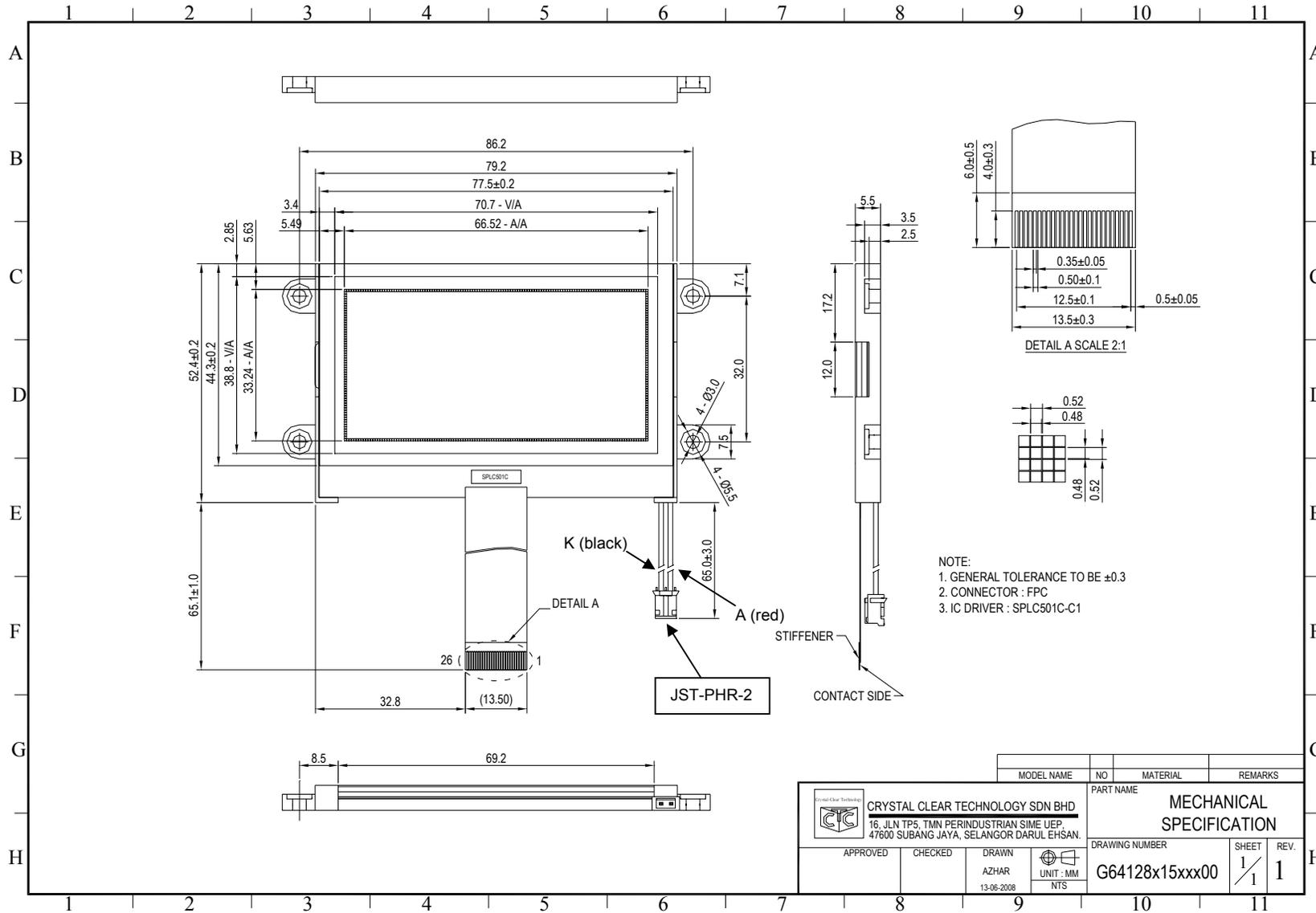
- a) The contrast can be adjusted by varying the LCD driving voltage  $V_0$
- b) Driving voltage should be kept within specified range, excess voltage shortens display life.
- c) Response time increases with decrease in temperature.
- d) Display may turn black or dark blue at temperature above its operational range, this is (however not pressing on the viewing area) may cause the segments to appear “fractured”.
- e) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear “fractured”.

#### 2.5 Storage

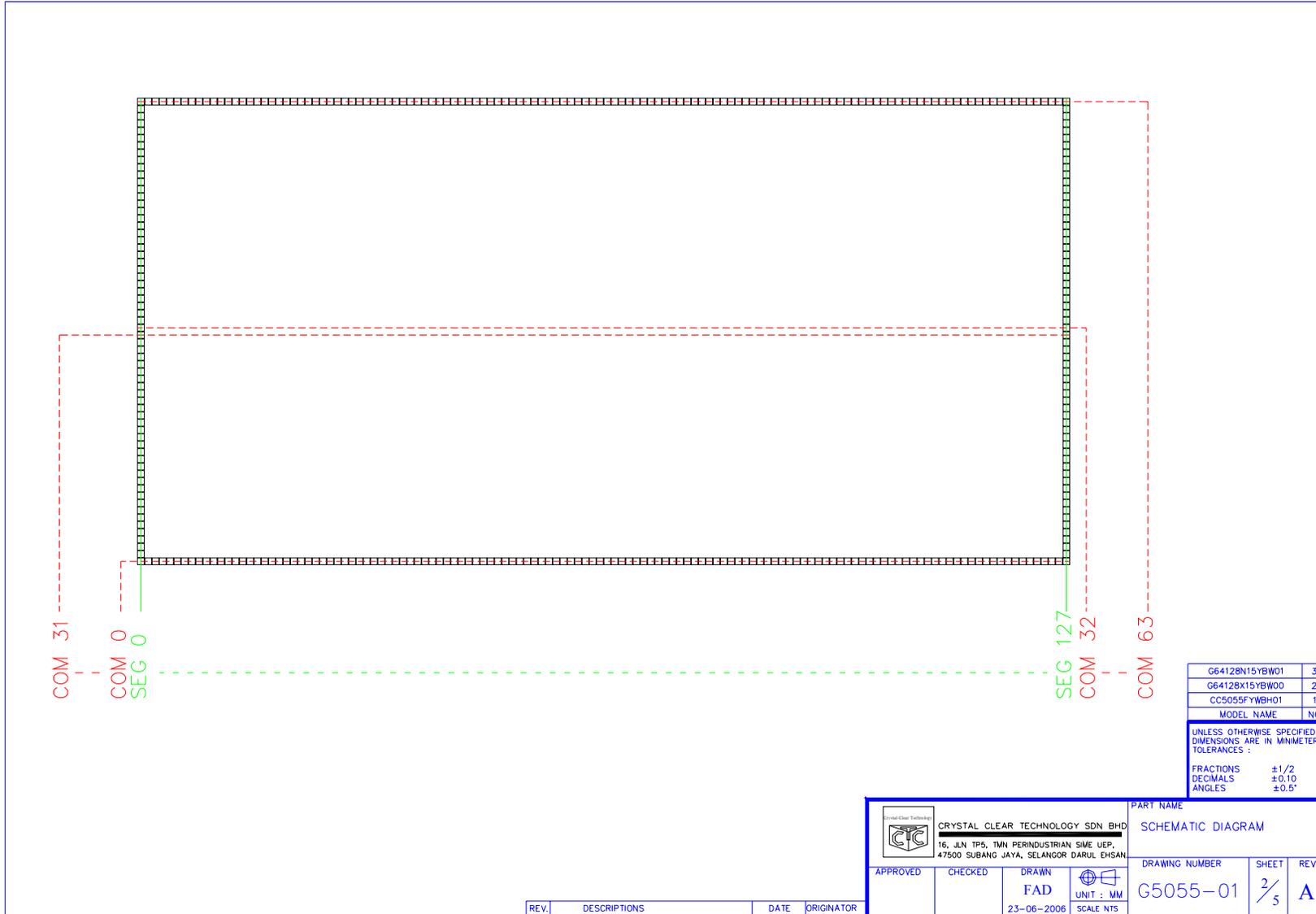
If any fluid leaks out of the damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

#### 2.6 Limited Warranty

Unless otherwise agreed between Crystal Clear Technology and customer, Crystal Clear Technology will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with Crystal Clear Technology acceptance standards, for a period of one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of Crystal Clear Technology is limited to repair and/or replacement on the terms set forth above. Crystal Clear Technology will not be responsible for any subsequent or consequential events.



MODEL NAME	NO	MATERIAL	REMARKS
CRYSTAL CLEAR TECHNOLOGY SDN BHD 16, JLN TP5, TMN PERINDUSTRIAN SIME UEP, 47600 SUBANG JAYA, SELANGOR DARUL EHSAN.			
APPROVED AZHAR 13-06-2008		CHECKED DRAWN UNIT : MM NTS	
PART NAME <b>MECHANICAL SPECIFICATION</b>		DRAWING NUMBER <b>G64128x15xxx00</b>	SHEET <b>1/1</b>
		REV. <b>1</b>	





**Crystal Clear Technology**  
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